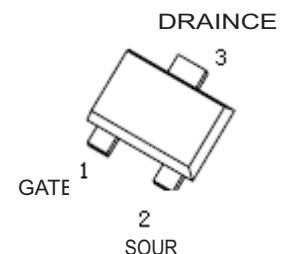
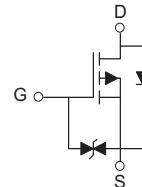




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## MT3139KM P-Channel MOSFET

$V_{(BR)DSS}$	$R_{DS(on)}\text{MAX}$	$I_D$
-20V	520mΩ@-4.5V	-0.66A
	700mΩ@-2.5V	
	950mΩ(TYP)@-1.8V	



### FEATURE

- Lead Free Product is Acquired
- Surface Mount Package
- P-Channel Switch with Low  $R_{DS(on)}$
- Operated at Low Logic Level Gate Drive

### APPLICATION

- Load/Power Switching
- Interfacing, Logic Switching
- Battery Management for Ultra Small Portable Electronics

SOT-723

MARKING : KD

Maximum ratings ( $T_a=25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	-20	V
Typical Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Continuous Drain Current (note 1)	$I_D$	-0.66	A
Pulsed Drain Current ( $t_p=10 \mu\text{ s}$ )	$I_{DM}$	-1.2	A
Power Dissipation (note 1)	$P_D$	150	mW
Thermal Resistance from Junction to Ambient (note 1)	$R_{\theta JA}$	833	°C/W
Operation Junction and Storage Temperature Range	$T_J, T_{STG}$	-55~+150	°C
Lead Temperature for Soldering Purposes(1/8" from case for 10 s)	$T_L$	260	°C



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## MOSFET ELECTRICAL CHARACTERISTICS

T<sub>a</sub>=25 °C unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>STATIC CHARACTERISTICS</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250µA	-20			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V			-1	µA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±10V, V <sub>DS</sub> = 0V			±20	µA
Gate threshold voltage (note 2)	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250µA	-0.35	-0.45	-1.1	V
Drain-source on-resistance (note 2)	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -1A		430	520	mΩ
		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -0.8A		624	700	mΩ
		V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -0.5A		950		mΩ
Forward transconductance (note 2)	g <sub>FS</sub>	V <sub>DS</sub> = -10V, I <sub>D</sub> = -0.54A		1.2		S
Diode forward voltage	V <sub>SD</sub>	I <sub>S</sub> = -0.5A, V <sub>GS</sub> = 0V			-1.2	V
<b>DYNAMIC CHARACTERISTICS (note 4)</b>						
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V, f = 1MHz		113	170	pF
Output capacitance	C <sub>oss</sub>			15	25	pF
Reverse transfer capacitance	C <sub>rss</sub>			9	15	pF
<b>SWITCHING CHARACTERISTICS (note 4)</b>						
Turn-on delay time (note 3)	t <sub>d(on)</sub>	V <sub>GS</sub> = -4.5V, V <sub>DS</sub> = -10V, I <sub>D</sub> = -200mA, R <sub>GEN</sub> = 10Ω		9		ns
Turn-on rise time (note 3)	t <sub>r</sub>			5.8		ns
Turn-off delay time (note 3)	t <sub>d(off)</sub>			32.7		ns
Turn-off fall time (note 3)	t <sub>f</sub>			20.3		ns

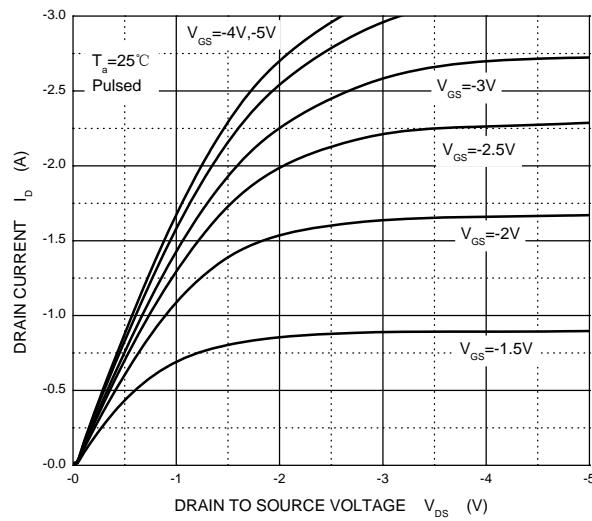
### Notes :

1. Surface mounted on FR4 board using the minimum recommended pad size.
2. Pulse Test : Pulse Width=300µs, Duty Cycle=2%.
3. Switching characteristics are independent of operating junction temperatures.
4. Guaranteed by design, not subject to producting.

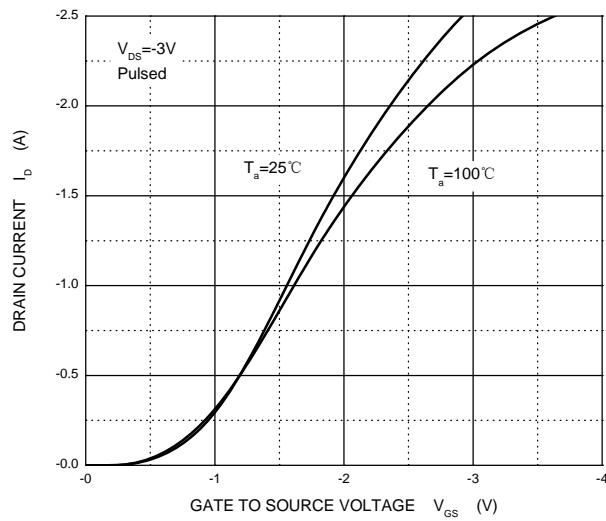


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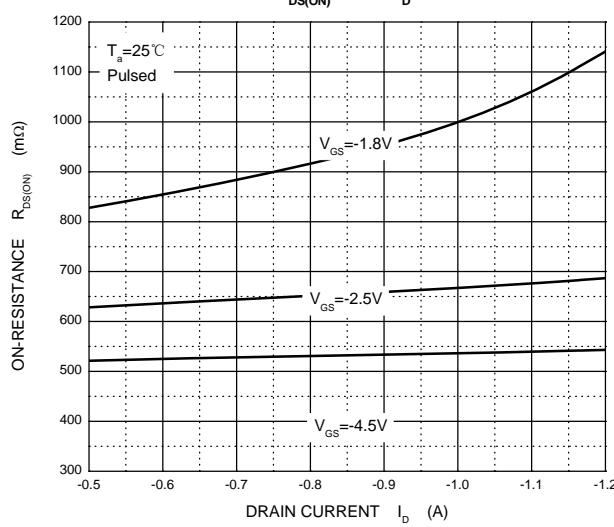
Output Characteristics



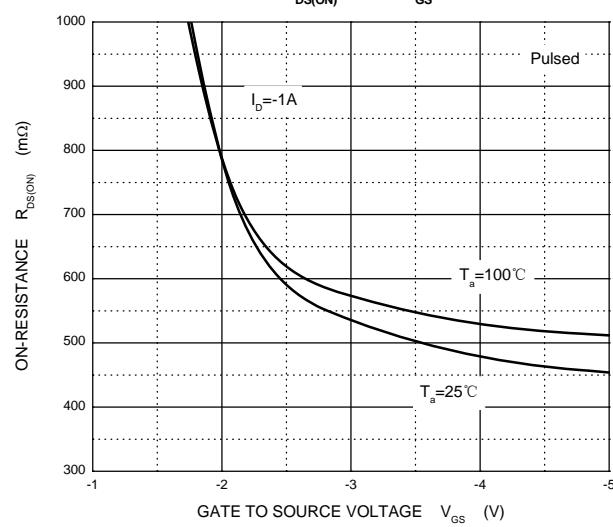
Transfer Characteristics



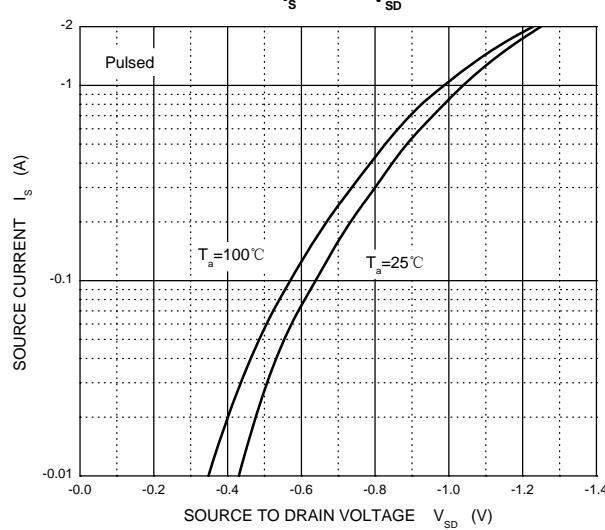
$R_{DS(ON)}$  —  $I_D$



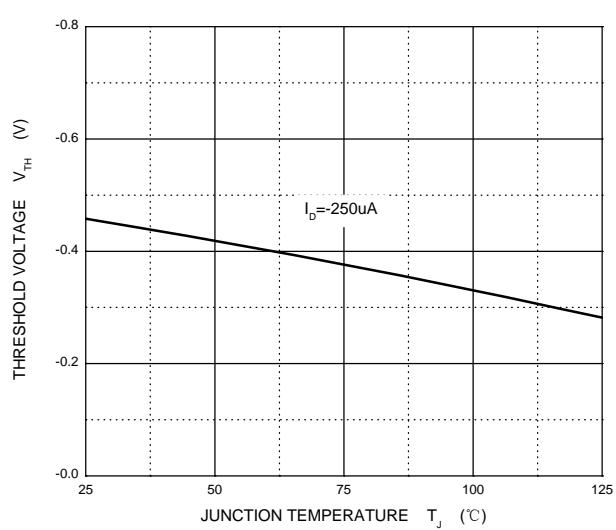
$R_{DS(ON)}$  —  $V_{GS}$



$I_S$  —  $V_{SD}$



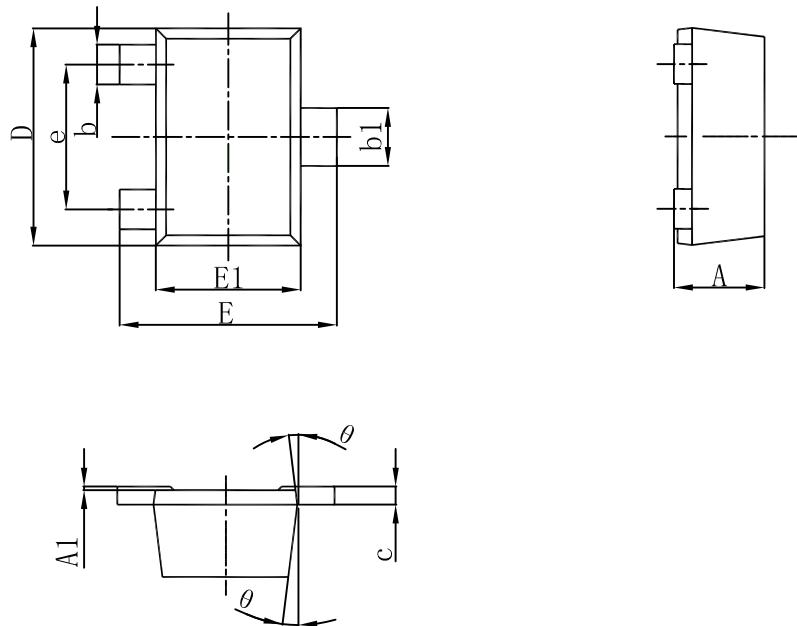
Threshold Voltage





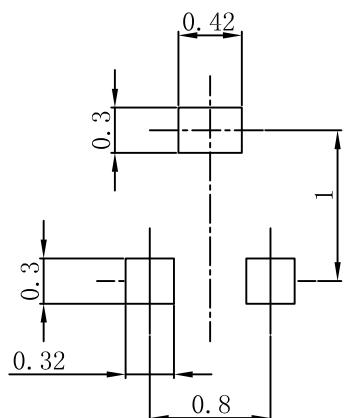
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### SOT-723 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.450	0.550	0.018	0.022
A1	0.000	0.050	0.000	0.002
b	0.170	0.270	0.007	0.011
b1	0.270	0.370	0.011	0.015
c	0.080	0.150	0.003	0.006
D	1.150	1.250	0.045	0.049
E	1.150	1.250	0.045	0.049
E1	0.750	0.850	0.030	0.033
e	0.800TYP.		0.031TYP.	
$\theta$	7° REF.		7° REF.	

### SOT-723 Suggested Pad Layout



#### Note:

1. Controlling dimension:in millimeters.
- 2.General tolerance: $\pm 0.05\text{mm}$ .
- 3.The pad layout is for reference purposes only.